

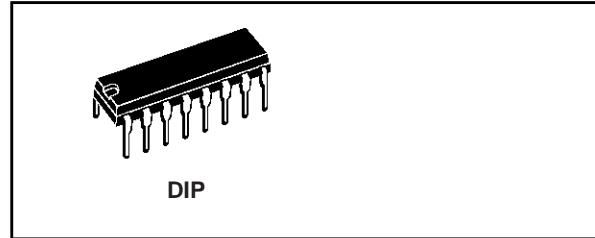


上海双岭电子有限公司

CC4050

## HEX BUFFER/CONVERTER (NON INVERTING)

- PROPAGATION DELAY TIME :  
 $t_{PD} = 40\text{ns}$  (TYP.) at  $V_{DD} = 10\text{V}$   $C_L = 50\text{pF}$
- HIGH TO LOW LEVEL LOGIC CONVERSION
- HIGH "SINK" AND "SOURCE" CURRENT CAPABILITY
- QUIESCENT CURRENT SPECIFIED UP TO 20V
- 5V, 10V AND 15V PARAMETRIC RATINGS
- INPUT LEAKAGE CURRENT  
 $I_I = 100\text{nA}$  (MAX) AT  $V_{DD} = 18\text{V}$   $T_A = 25^\circ\text{C}$
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC JESD13B " STANDARD SPECIFICATIONS FOR DESCRIPTION OF B SERIES CMOS DEVICES"



### ORDER CODES

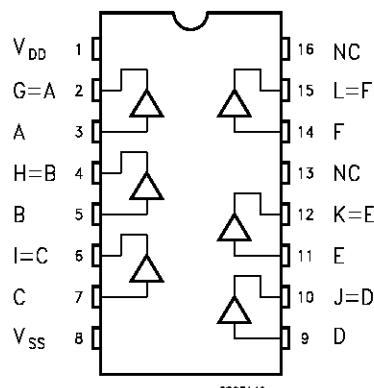
PACKAGE	TUBE	T & R
DIP	CC4050	

### DESCRIPTION

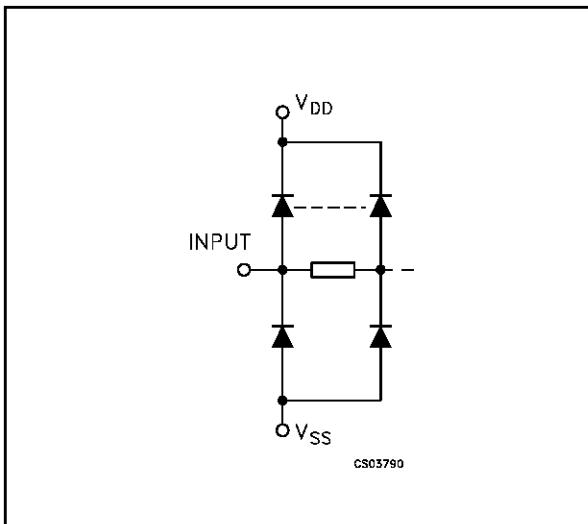
The CC4050 is a monolithic integrated circuit fabricated in Metal Oxide Semiconductor technology available in DIP and SOP packages. It is an non inverting Hex Buffer/Converter and feature logic level conversions using only one supply voltage ( $V_{DD}$ ).

The input high level signal ( $V_{IH}$ ) can exceed the  $V_{DD}$  supply voltage when these devices are used for logic level conversions. This device is intended for use as CMOS to DTL/TTL converters and can drive directly two DTL/TTL loads ( $V_{DD}=5\text{V}$ ,  $V_{OL}\leq 0.4\text{V}$  and  $I_{OL}\leq 3.2\text{mA}$ ).

### PIN CONNECTION



## INPUT EQUIVALENT CIRCUIT



## PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
3, 5, 7, 9, 11, 14	A, B, C, D, E, F	Data Inputs
2, 4, 6, 10, 12, 15	G, H, I, J, K, L	Data Outputs
13 , 16	NC	Not Connected
8	$V_{SS}$	Negative Supply Voltage
1	$V_{DD}$	Positive Supply Voltage

## TRUTH TABLE

INPUTS	OUTPUTS
A, B, C, D,E, F	G, H, I, J, K, L
L	L
H	H

## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage	-0.5 to +20	V
$V_I$	DC Input Voltage	-0.5 to $V_{DD} + 0.5$	V
$I_I$	DC Input Current	$\pm 10$	mA
$P_D$	Power Dissipation per Package	200	mW
	Power Dissipation per Output Transistor	100	mW
$T_{op}$	Operating Temperature	-55 to +125	°C
$T_{stg}$	Storage Temperature	-65 to +150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

All voltage values are referred to  $V_{SS}$  pin voltage.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage	3 to 18	V
$V_I$	Input Voltage	0 to $V_{DD}$	V
$T_{op}$	Operating Temperature	-55 to 125	°C

## DC SPECIFICATIONS

Symbol	Parameter	Test Condition				Value						Unit	
		$V_I$ (V)	$V_O$ (V)	$ I_{OL} $ ( $\mu$ A)	$V_{DD}$ (V)	$T_A = 25^\circ C$			$-40 \text{ to } 85^\circ C$		$-55 \text{ to } 125^\circ C$		
						Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
$I_L$	Quiescent Current	0/5			5		0.02	1		30		30	$\mu A$
		0/10			10		0.02	2		60		60	
		0/15			15		0.02	4		120		120	
		0/18			18		0.04	20		600		600	
$V_{OH}$	High Level Output Voltage	0/5		<1	5	4.95			4.95		4.95		V
		0/10		<1	10	9.95			9.95		9.95		
		0/15		<1	15	14.95			14.95		14.95		
$V_{OL}$	Low Level Output Voltage	5/0		<1	5		0.05			0.05		0.05	V
		10/0		<1	10		0.05			0.05		0.05	
		15/0		<1	15		0.05			0.05		0.05	
$V_{IH}$	High Level Input Voltage	0.5/4.5		<1	5	3.5			3.5		3.5		V
		1/9		<1	10	7			7		7		
		1.5/13.5		<1	15	11			11		11		
$V_{IL}$	Low Level Input Voltage	4.5/0.5		<1	5			1.5		1.5		1.5	V
		9/1		<1	10			3		3		3	
		13.5/1.5		<1	15			4		4		4	
$I_{OH}$	Output Drive Current	0/5	2.5	<1	5	-1.25	-6.4		-0.42		-0.42		mA
		0/5	4.6	<1	5	-0.51	-1.6		-0.38		-0.38		
		0/10	9.5	<1	10	-1.25	-3.6		-1		-1		
		0/15	13.5	<1	15	-3.75	-12		-3		-3		
$I_{OL}$	Output Sink Current	0/5	0.4	<1	5	3.2	6.4		2.6		2.6		mA
		0/10	0.5	<1	10	8	16		6.6		6.6		
		0/15	1.5	<1	15	24	48		19		19		
$I_I$	Input Leakage Current	0/18	Any Input	18			$\pm 10^{-5}$	$\pm 0.1$		$\pm 1$		$\pm 1$	$\mu A$
$C_I$	Input Capacitance		Any Input				5	7.5					pF

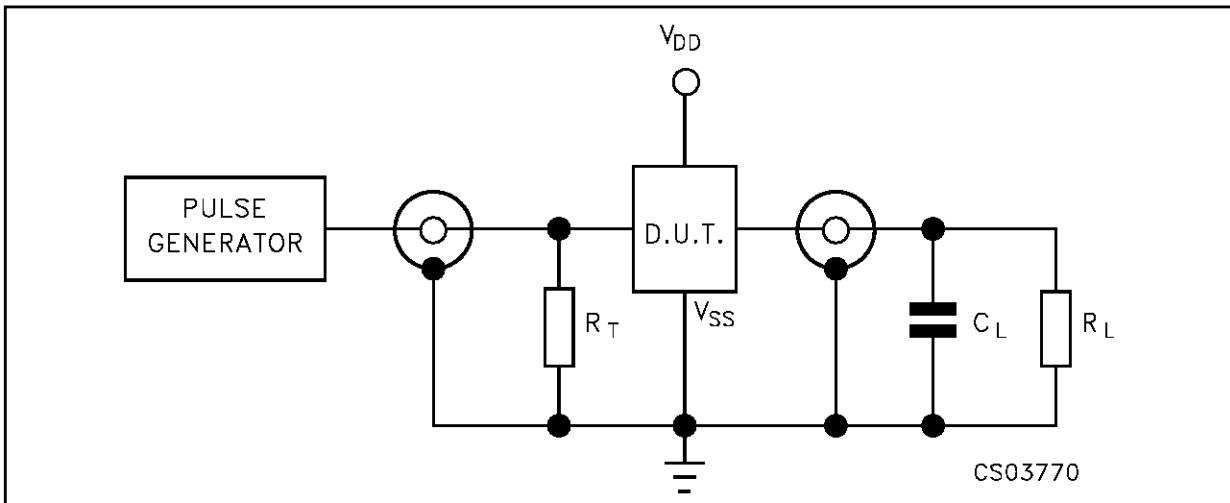
The Noise Margin for both "1" and "0" level is: 1V min. with  $V_{DD}=5V$ , 2V min. with  $V_{DD}=10V$ , 2.5V min. with  $V_{DD}=15V$

DYNAMIC ELECTRICAL CHARACTERISTICS ( $T_{amb} = 25^\circ C$ ,  $C_L = 50pF$ ,  $R_L = 200K\Omega$ ,  $t_r = t_f = 20 ns$ )

Symbol	Parameter	Test Condition			Value (*)			Unit
		$V_{DD}$ (V)	$V_I$ (V)		Min.	Typ.	Max.	
$t_{TLH}$	Output Transition Time	5	5			80	160	ns
		10	10			40	80	
		15	15			30	60	
$t_{THL}$	Output Transition Time	5	5			30	60	ns
		10	10			20	40	
		15	15			15	30	
$t_{PLH}$	Propagation Delay Time	5	5			70	140	ns
		10	10			40	80	
		5	10			45	90	
		15	15			30	60	
		5	15			40	80	
$t_{PHL}$	Propagation Delay Time	5	5			55	110	ns
		10	10			22	55	
		5	10			50	100	
		15	15			15	30	
		5	15			50	100	

(\*) Typical temperature coefficient for all  $V_{DD}$  value is  $0.3\%/\text{ }^\circ\text{C}$ .

## TEST CIRCUIT



$C_L = 50pF$  or equivalent (includes jig and probe capacitance)

$R_L = 200K\Omega$

$R_T = Z_{OUT}$  of pulse generator (typically  $50\Omega$ )